



GaAs MMIC SOT26 SPDT SWITCH, DC - 3 GHz

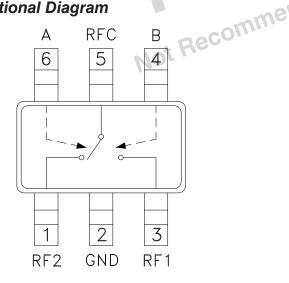
Typical Applications

Designer's Kit Available

The HMC221 & HMC221E is ideal for:

- ISM Applications
- PCMCIA Wireless Cards
- Cellular Applications

Functional Diagram



Features

RoHS-Compliant Product Low Insertion Loss: 0.4 dB Ultra Small Package: SOT26 Positive Control: 0/+3V @ 10 uA Input IP3: +45 dBm Included in the HMC-DK005 Designer's Kits

General Description

The HMC221 and HMC221E are low-cost SPDT switches in a 6-lead SOT26 plastic package for use in general switching applications which require very low insertion loss and very small size. These devices can control signals from DC to 3 GHz and is especially suited for 900 MHz, 1.8 - 2.2 GHz, and 2.4 GHz ISM applications with less than 1 dB loss. The design provides exceptional insertion loss performance, ideal for filter and receiver switching. RF1 and RF2 are reflective shorts when "Off". The two control voltages require a minimal amount of DC current and offer compatibility with most CMOS & TTL logic families. See HMC197 for same performance in an alternate SOT26 pin-out. The HMC221E is a RoHScompliant product.

Electrical Specifications, $T_{A} = +25^{\circ}$ C, Vctl = 0/+3 to +8 Vdc

Parameter	Frequency	Min.	Тур.	Max.	Units
Insertion Loss	DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz DC - 3.0 GHz		0.4 0.45 0.6 0.8	0.7 0.8 0.9 1.1	dB dB dB dB
Isolation	DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz DC - 3.0 GHz	24 24 21 14	28 28 25 18		dB dB dB dB
Return Loss	DC - 1.0 GHz DC - 2.0 GHz DC - 2.5 GHz DC - 3.0 GHz	20 17 16 11	23 22 20 15		dB dB dB dB
Input Power for 1 dB Compression (Vctl = 0/+5V)	0.5 - 1.0 GHz 0.5 - 3.0 GHz	25 23	30 29		dBm dBm
Input Third Order Intercept (Vctl = 0/+5V) (Two-tone Input Power = +7 dBm Each Tone)	0.5 - 1.0 GHz 0.5 - 3.0 GHz	40 38	45 43		dBm dBm
Switching Characteristics	DC - 3.0 GHz				
tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)			3 10		ns ns

For price, delivery and to place orders: Hittite Microwave Corporation, 20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com Application Support: Phone: 978-250-3343 or apps@hittite.com



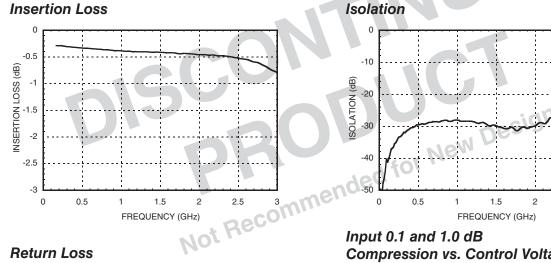


HMC221 / 221E

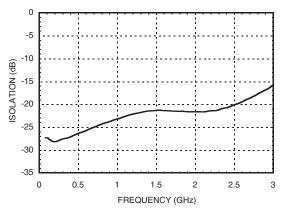
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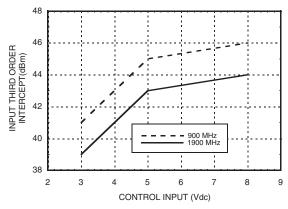
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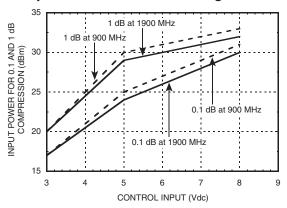
Return Loss



Input Third Order Intercept Point vs. Control Voltage



Input 0.1 and 1.0 dB **Compression vs. Control Voltage**



Distortion vs. Control Voltage

Control Input	Third Order Intercept (dBm) +7 dBm Each Tone		
(Vdc)	900 MHz 1900 MHz		
+3	41	39	
+5	45	43	
+8	46	44	

Truth Table

*Control Input Voltage Tolerances are ± 0.2 Vdc.

Contro	I Input*	Control Current		Signal Path		
A (Vdc)	B (Vdc)	la (uA)	lb (uA)	RF to RF1	RF to RF2	
0	+3	-10	10	ON	OFF	
+3	0	10	-10	OFF	ON	
0	+5	-55	55	ON	OFF	
+5	0	55	-55	OFF	ON	
0	+7	-210	210	ON	OFF	
+7	0	210	-210	OFF	ON	
0	+8	-280	280	ON	OFF	
+8	0	280	-280	OFF	ON	

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Compression vs. Control Voltage

	Carrier at 900 MHz		Carrier at 1900 MHz		
Control Input	Input Power for 0.1 dB Compression	Input Power for 1.0 dB Compression	Input Power for 0.1 dB Compression	Input Power for 1.0 dB Compression	
(Vdc)	(dBm)	(dBm)	(dBm)	(dBm)	
+3	17	20	17	20	
+5	25	30	24	29	
+8	31	33	30	32	

Caution: Do not operate in 1dB compression at power levels above +31 dBm (Vctl = +5 Vdc) and do not "hot switch" power levels greater than +20 dBm (Vctl = +5Vdc). DC blocks are required at ports RFC, RF1 and RF2.

Outline Drawing

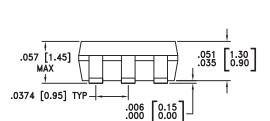
Absolute Maximum Ratings

Control Voltage Range (A & B)		-0.2 to +12 Vdc			
Storage Temperature		-65 to +150 °C			
Operating Temperature		-40 to +85 °C			
ESD Sensitivity (HBM)		Class 1A			



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

 $\begin{array}{c} & & & & & \\ & & & & & \\ & & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & &$



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.118 3.00 .102 2.60 LOT NUMBER - .009 .009 .009 .009 .008

NOTES:

1. LEADFRAME MATERIAL: COPPER ALLOY

2. DIMENSIONS ARE IN INCHES [MILLIMETERS].

A DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.

A DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.

5. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking
HMC221 Low Stress Injection Molded Plastic		Sn/Pb Solder	MSL1 ^[1]	H221
HMC221E RoHS-compliant Low Stress Injection Molded Plastic		100% matte Sn	MSL1 ^[2]	221E

[1] Max peak reflow temperature of 235 $^\circ\text{C}$

[2] Max peak reflow temperature of 260 $^\circ\text{C}$

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B

O REC

74HC04 or 74HCT04

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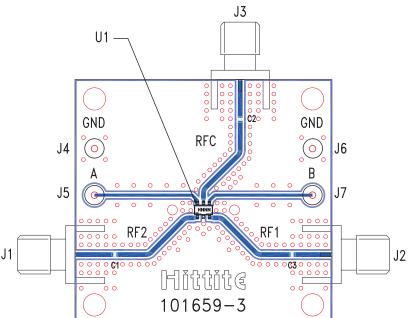


Typical Application Circuit

Notes:

- 1. Set logic gate and switch Vdd = +3V to +5V and use HCT series logic to provide a TTL driver interface.
- 2. Control inputs A/B can be driven directly with CMOS logic (HC) with Vdd of 5 to 8 Volts applied to the CMOS logic gates.
- 3. DC Blocking capacitors are required for each RF port as shown. Capacitor value determines lowest frequency of operation.
- Not Recommended 4. Highest RF signal power capability is achieved with Vdd = +8V and A/B set to 0/+8V.





RF2

RF1 O

GND

2

3

CTLO

Vdd o

List of Materials for Evaluation PCB 101675 [1]

Item	Description	
J1 - J3 PCB Mount SMA RF Connector		
J4 - J7	DC Pin	
C1 - C3	330 pF capacitor, 0402 Pkg.	
U1	HMC221 / HMC221E SPDT Switch	
PCB [2]	101659 Evaluation PCB	

[1] Reference this number when ordering complete evaluation PCB [2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 Ohm impedance and the package ground leads and package bottom should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.

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